



# PMPB25ENE

30 V, N-channel Trench MOSFET

26 April 2018

Product data sheet

## 1. General description

N-channel enhancement mode Field-Effect Transistor (FET) in a leadless medium power DFN2020MD-6 (SOT1220) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

## 2. Features and benefits

- Extended temperature range  $T_j = 175\text{ °C}$
- Small and leadless ultra thin SMD plastic package: 2 x 2 x 0.65 mm
- Tin-plated 100 % solderable side pads for optical solder inspection
- ElectroStatic Discharge (ESD) protection > 2 kV HBM
- Trench MOSFET technology

## 3. Applications

- Relay driver
- High-speed line driver
- Low-side load switch
- Switching circuits

## 4. Quick reference data

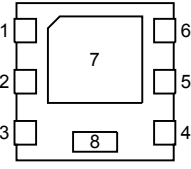
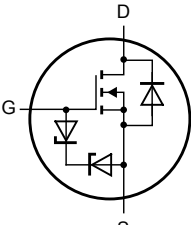
Table 1. Quick reference data

| Symbol                        | Parameter                        | Conditions  | Min | Typ | Max | Unit       |
|-------------------------------|----------------------------------|---|-----|-----|-----|------------|
| $V_{DS}$                      | drain-source voltage             | $T_j = 25\text{ °C}$  | -   | -   | 30  | V          |
| $V_{GS}$                      | gate-source voltage              |   | -20 | -   | 20  | V          |
| $I_D$                         | drain current                    | $V_{GS} = 10\text{ V}; T_{amb} = 25\text{ °C}; t \leq 5\text{ s}$ | [1] | -   | 10  | A          |
| <b>Static characteristics</b> |                                  |   |     |     |     |            |
| $R_{DSon}$                    | drain-source on-state resistance | $V_{GS} = 10\text{ V}; I_D = 7.2\text{ A}; T_j = 25\text{ °C}$    | -   | 17  | 24  | m $\Omega$ |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm<sup>2</sup>.

## 5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description | Simplified outline   | Graphic symbol   |
|-----|--------|-------------|--|--|
| 1   | D      | drain       |  <p>Transparent top view<br/><b>DFN2020MD-6 (SOT1220)</b></p> |  <p>017aaa255</p> |
| 2   | D      | drain       |  |  |
| 3   | G      | gate        |  |  |
| 4   | S      | source      |  |  |
| 5   | D      | drain       |  |  |
| 6   | D      | drain       |  |  |
| 7   | D      | drain       |  |  |
| 8   | S      | source      |  |  |

## 6. Ordering information

Table 3. Ordering information

| Type number | Package     |   |         |
|-------------|-------------|---|---------|
|             | Name        | Description   | Version |
| PMPB25ENE   | DFN2020MD-6 | DFN2020MD-6: plastic thermal enhanced ultra thin small outline package; no leads; 6 terminals | SOT1220 |

## 7. Marking

Table 4. Marking codes

| Type number | Marking code |
|-------------|--------------|
| PMPB25ENE   | 3V           |

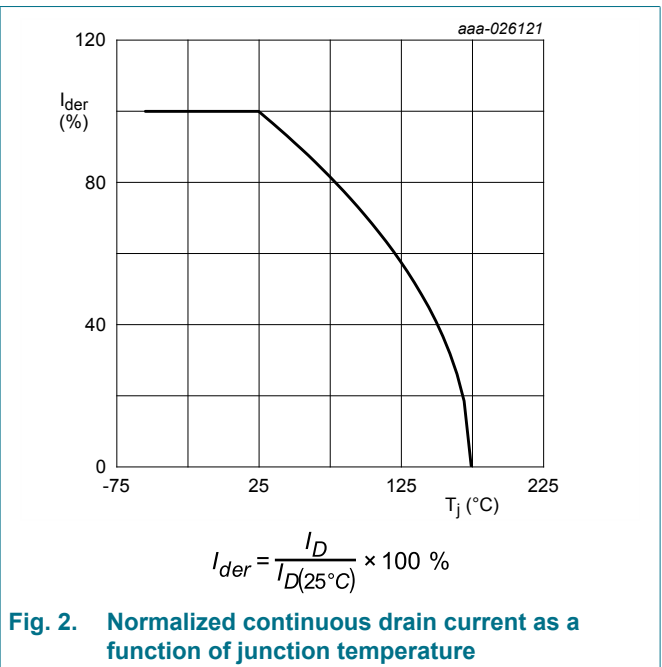
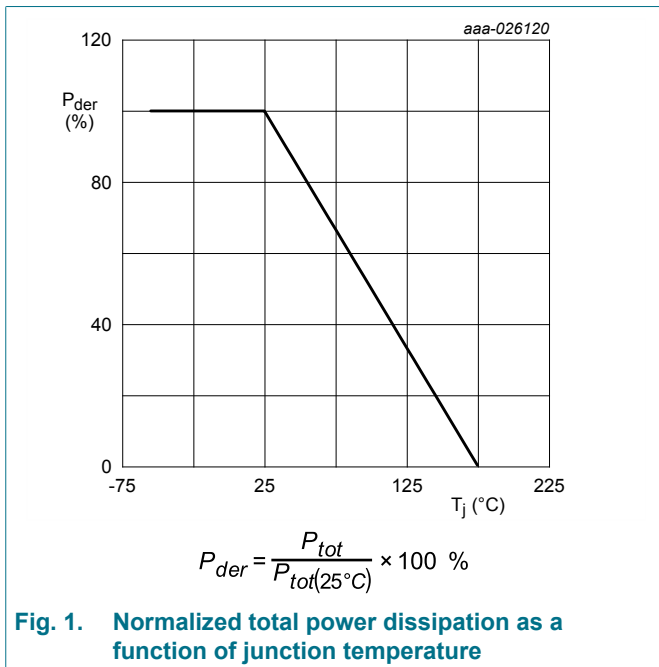
## 8. Limiting values

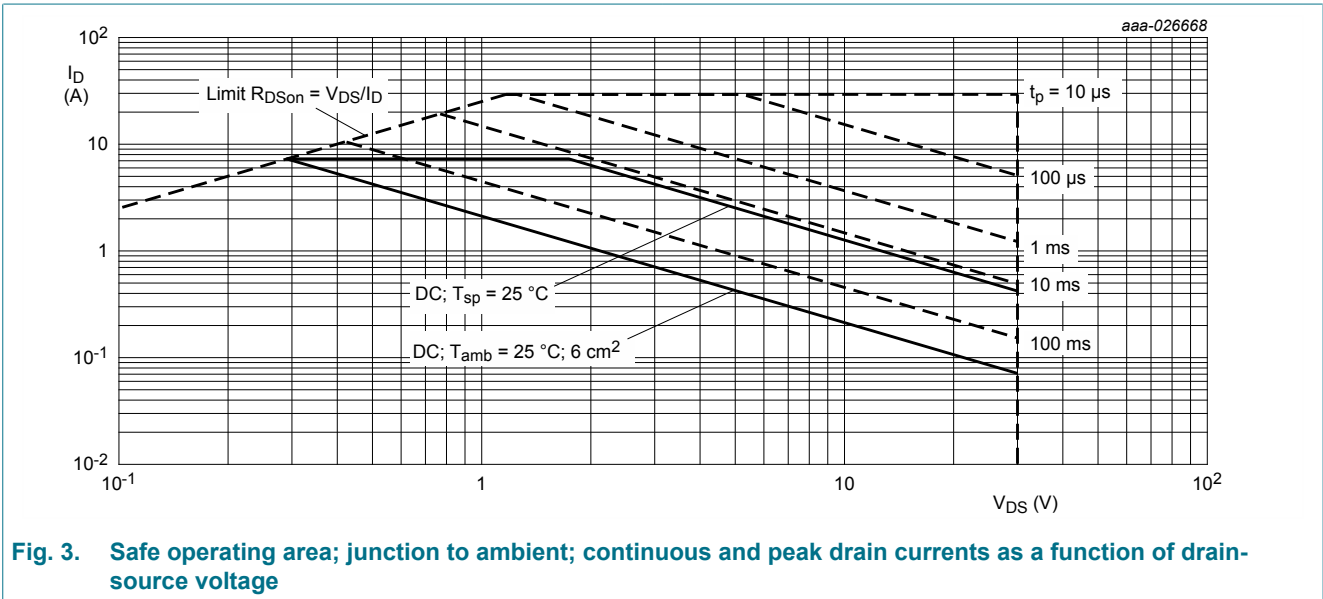
**Table 5. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol                    | Parameter               | Conditions   |     | Min | Max  | Unit |
|---------------------------|-------------------------|--|-----|-----|------|------|
| V <sub>DS</sub>           | drain-source voltage    | T <sub>j</sub> = 25 °C   |     | -   | 30   | V    |
| V <sub>GS</sub>           | gate-source voltage     |  |     | -20 | 20   | V    |
| I <sub>D</sub>            | drain current           | V <sub>GS</sub> = 10 V; T <sub>amb</sub> = 25 °C; t ≤ 5 s      | [1] | -   | 10   | A    |
|                           |                         | V <sub>GS</sub> = 10 V; T <sub>amb</sub> = 25 °C               | [1] | -   | 7.2  | A    |
|                           |                         | V <sub>GS</sub> = 10 V; T <sub>amb</sub> = 100 °C              | [1] | -   | 4.6  | A    |
| I <sub>DM</sub>           | peak drain current      | T <sub>amb</sub> = 25 °C; single pulse; t <sub>p</sub> ≤ 10 μs |     | -   | 29   | A    |
| P <sub>tot</sub>          | total power dissipation | T <sub>amb</sub> = 25 °C                                       | [1] | -   | 2.1  | W    |
|                           |                         | T <sub>amb</sub> = 25 °C; t ≤ 5 s                              | [1] | -   | 4.1  | W    |
|                           |                         | T <sub>sp</sub> = 25 °C  |     | -   | 12.5 | W    |
| T <sub>j</sub>            | junction temperature    |  |     | -55 | 175  | °C   |
| T <sub>amb</sub>          | ambient temperature     |  |     | -55 | 175  | °C   |
| T <sub>stg</sub>          | storage temperature     |  |     | -65 | 175  | °C   |
| <b>Source-drain diode</b> |                         |  |     |     |      |      |
| I <sub>S</sub>            | source current          | T <sub>amb</sub> = 25 °C                                       | [1] | -   | 2.1  | A    |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm<sup>2</sup>.





## 9. Thermal characteristics

Table 6. Thermal characteristics

| Symbol         | Parameter  | Conditions                |     | Min | Typ | Max | Unit |
|----------------|--|---------------------------|-----|-----|-----|-----|------|
| $R_{th(j-a)}$  | thermal resistance from junction to ambient      | in free air               | [1] | -   | 231 | 265 | K/W  |
|                |  |                           | [2] | -   | 63  | 72  | K/W  |
|                |  | in free air; $t \leq 5$ s | [2] | -   | 32  | 37  | K/W  |
| $R_{th(j-sp)}$ | thermal resistance from junction to solder point |                           |     | -   | 9   | 12  | K/W  |

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 6 cm<sup>2</sup>.

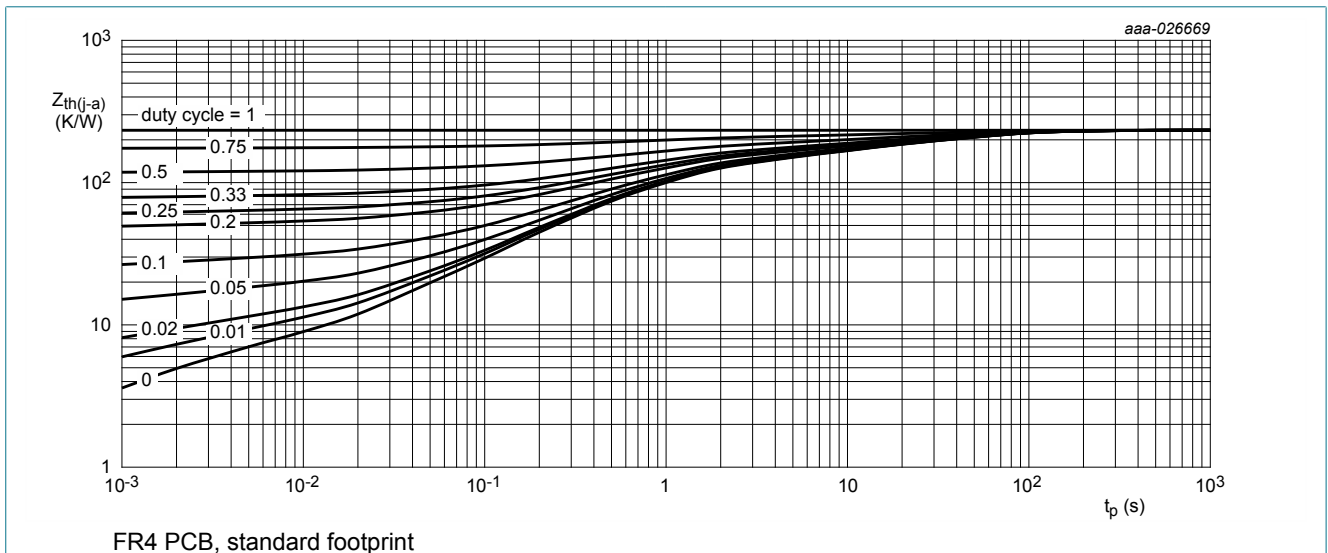


Fig. 4. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

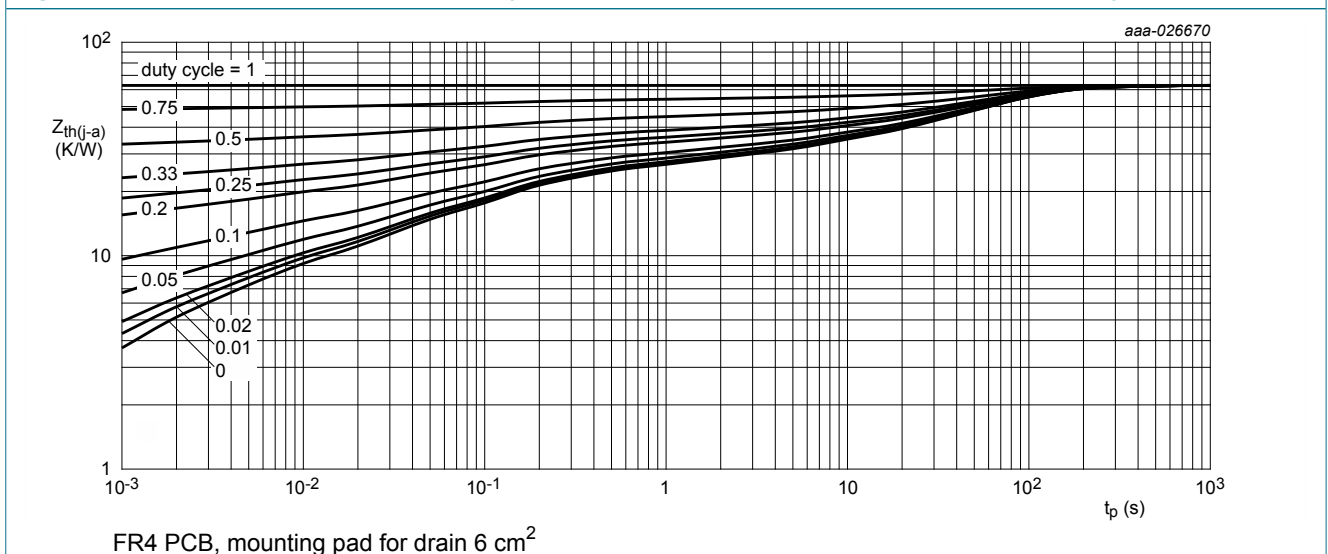


Fig. 5. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

## 10. Characteristics

Table 7. Characteristics

| Symbol                         | Parameter                        | Conditions  | Min  | Typ | Max  | Unit       |
|--------------------------------|----------------------------------|---|--|-----|------|------------|
| <b>Static characteristics</b>  |                                  |   |  |     |      |            |
| $V_{(BR)DSS}$                  | drain-source breakdown voltage   | $I_D = 250 \mu A$ ; $V_{GS} = 0 V$ ; $T_j = 25 \text{ }^\circ C$                        | 30   | -   | -    | V          |
| $V_{GSth}$                     | gate-source threshold voltage    | $I_D = 250 \mu A$ ; $V_{DS} = V_{GS}$ ; $T_j = 25 \text{ }^\circ C$                     | 1  | 1.5 | 2.5  | V          |
| $I_{DSS}$                      | drain leakage current            | $V_{DS} = 30 V$ ; $V_{GS} = 0 V$ ; $T_j = 25 \text{ }^\circ C$                          | -  | -   | 1    | $\mu A$    |
| $I_{GSS}$                      | gate leakage current             | $V_{GS} = 20 V$ ; $V_{DS} = 0 V$ ; $T_j = 25 \text{ }^\circ C$                          | -  | -   | 10   | $\mu A$    |
|                                |                                  | $V_{GS} = -20 V$ ; $V_{DS} = 0 V$ ; $T_j = 25 \text{ }^\circ C$                         | -  | -   | -10  | $\mu A$    |
|                                |                                  | $V_{GS} = 4.5 V$ ; $V_{DS} = 0 V$ ; $T_j = 25 \text{ }^\circ C$                         | -  | -   | 200  | nA         |
|                                |                                  | $V_{GS} = -4.5 V$ ; $V_{DS} = 0 V$ ; $T_j = 25 \text{ }^\circ C$                        | -  | -   | -200 | nA         |
| $R_{DSon}$                     | drain-source on-state resistance | $V_{GS} = 10 V$ ; $I_D = 7.2 A$ ; $T_j = 25 \text{ }^\circ C$                           | -  | 17  | 24   | m $\Omega$ |
|                                |                                  | $V_{GS} = 10 V$ ; $I_D = 7.2 A$ ; $T_j = 175 \text{ }^\circ C$                          | -  | 28  | 40   | m $\Omega$ |
|                                |                                  | $V_{GS} = 4.5 V$ ; $I_D = 6.2 A$ ; $T_j = 25 \text{ }^\circ C$                          | -  | 28  | 32   | m $\Omega$ |
| $g_{fs}$                       | forward transconductance         | $V_{DS} = 10 V$ ; $I_D = 7.2 A$ ; $T_j = 25 \text{ }^\circ C$                           | -  | 25  | -    | S          |
| $R_G$                          | gate resistance                  | $f = 1 \text{ MHz}$   | -  | 6.8 | -    | $\Omega$   |
| <b>Dynamic characteristics</b> |                                  |   |  |     |      |            |
| $Q_{G(tot)}$                   | total gate charge                | $V_{DS} = 15 V$ ; $I_D = 7 A$ ; $V_{GS} = 10 V$ ;<br>$T_j = 25 \text{ }^\circ C$        | -  | 13  | 19   | nC         |
| $Q_{GS}$                       | gate-source charge               |   | -  | 1.5 | -    | nC         |
| $Q_{GD}$                       | gate-drain charge                |   | -  | 2.8 | -    | nC         |
| $C_{iss}$                      | input capacitance                | $V_{DS} = 15 V$ ; $f = 1 \text{ MHz}$ ; $V_{GS} = 0 V$ ;<br>$T_j = 25 \text{ }^\circ C$ | -  | 607 | -    | pF         |
| $C_{oss}$                      | output capacitance               |   | -  | 113 | -    | pF         |
| $C_{rss}$                      | reverse transfer capacitance     |   | -  | 88  | -    | pF         |
| $t_{d(on)}$                    | turn-on delay time               |   | $V_{DS} = 15 V$ ; $I_D = 7 A$ ; $V_{GS} = 10 V$ ;<br>$R_{G(ext)} = 6 \Omega$ ; $T_j = 25 \text{ }^\circ C$ | -   | 6    | -          |
| $t_r$                          | rise time                        | -   |  | 29  | -    | ns         |
| $t_{d(off)}$                   | turn-off delay time              | -   |  | 28  | -    | ns         |
| $t_f$                          | fall time                        | -   |  | 12  | -    | ns         |
| <b>Source-drain diode</b>      |                                  |   |  |     |      |            |
| $V_{SD}$                       | source-drain voltage             | $I_S = 2.1 A$ ; $V_{GS} = 0 V$ ; $T_j = 25 \text{ }^\circ C$                            | -  | 0.8 | 1.2  | V          |

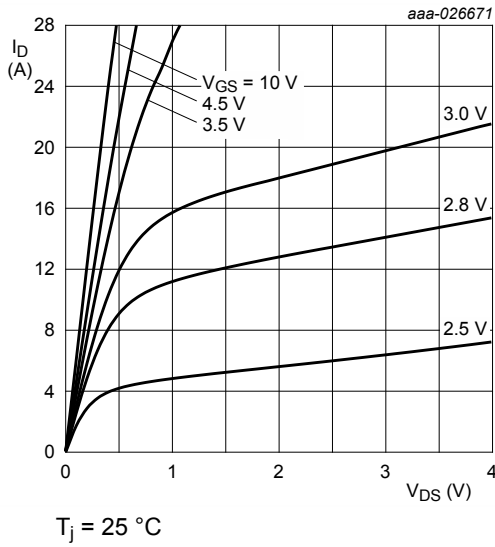


Fig. 6. Output characteristics: drain current as a function of drain-source voltage; typical values

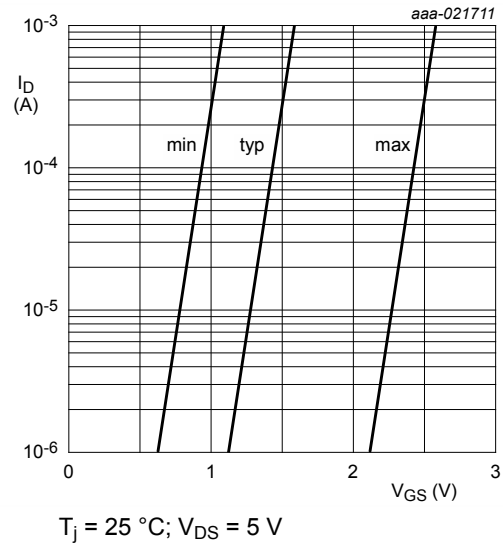


Fig. 7. Sub-threshold drain current as a function of gate-source voltage

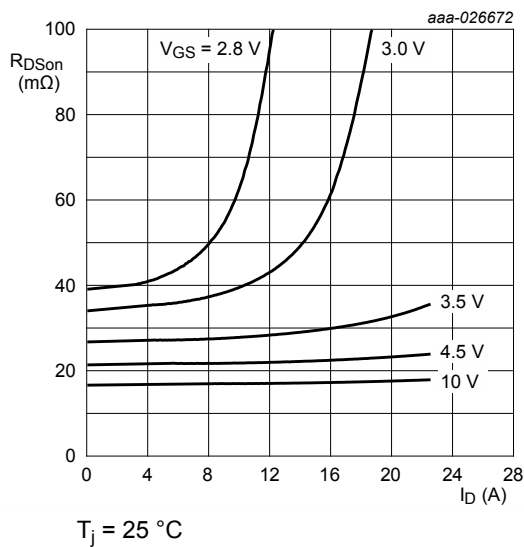


Fig. 8. Drain-source on-state resistance as a function of drain current; typical values

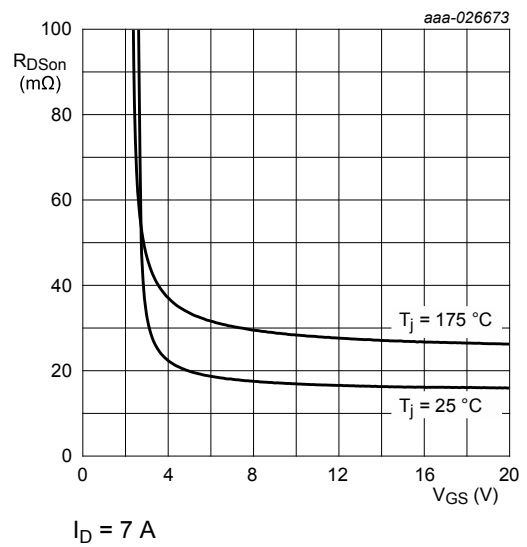
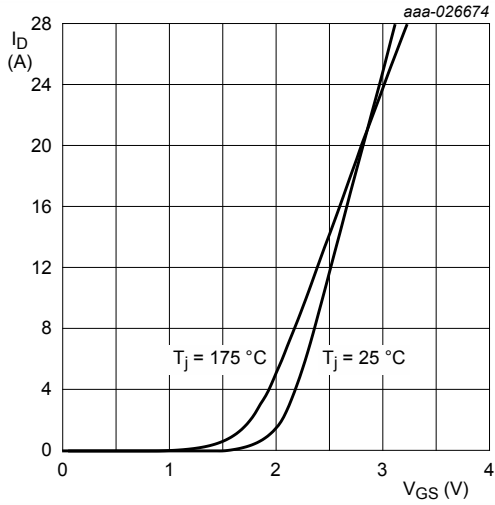
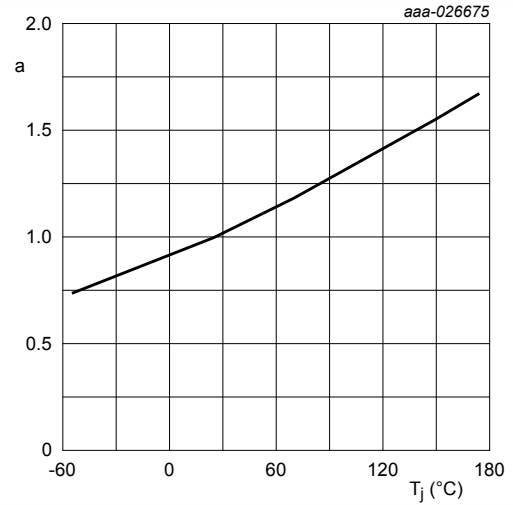


Fig. 9. Drain-source on-state resistance as a function of drain current; typical values



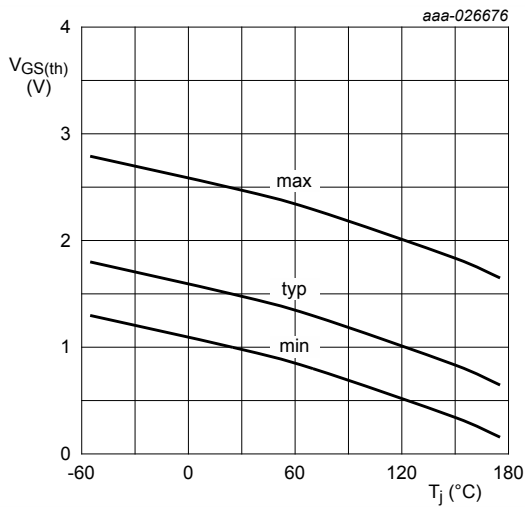
$$V_{DS} > I_D \times R_{DSon}$$

**Fig. 10. Transfer characteristics: drain current as a function of gate-source voltage; typical values**



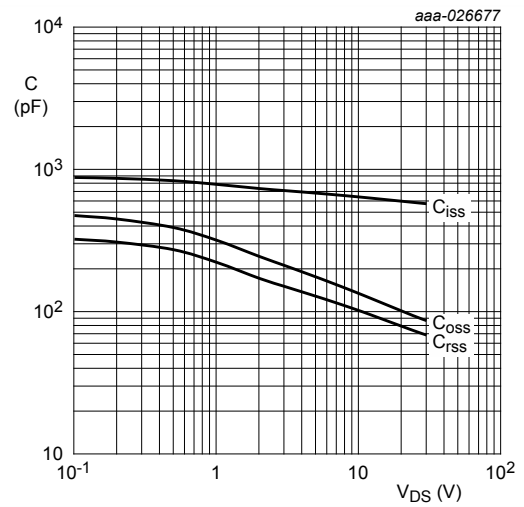
$$a = \frac{R_{DSon}}{R_{DSon(25^\circ C)}}$$

**Fig. 11. Normalized drain-source on-state resistance as a function of junction temperature; typical values**



$$I_D = 250 \mu A; V_{DS} = V_{GS}$$

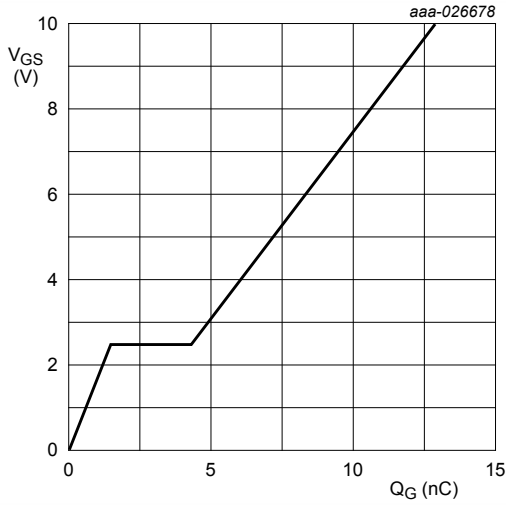
**Fig. 12. Gate-source threshold voltage as a function of junction temperature**



$$f = 1 \text{ MHz}; V_{GS} = 0 \text{ V}$$

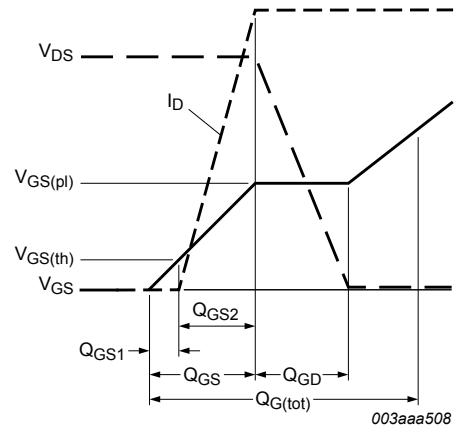
**Fig. 13. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values**



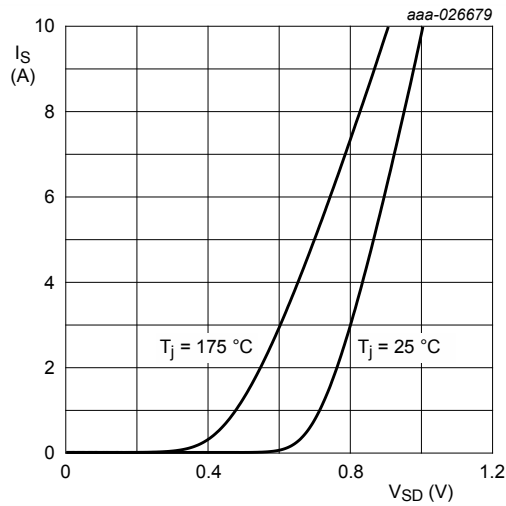


$V_{DS} = 15 \text{ V}; I_D = 7 \text{ A}; T_{amb} = 25 \text{ }^\circ\text{C}$

**Fig. 14. Gate-source voltage as a function of gate charge; typical values**



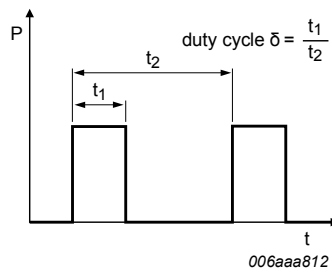
**Fig. 15. Gate charge waveform definitions**



$V_{GS} = 0 \text{ V}$

**Fig. 16. Source current as a function of source-drain voltage; typical values**

## 11. Test information



**Fig. 17. Duty cycle definition**

## 12. Package outline

DFN2020MD-6: plastic thermal enhanced ultra thin small outline package; no leads;  
6 terminals; body 2 x 2 x 0.65 mm

SOT1220

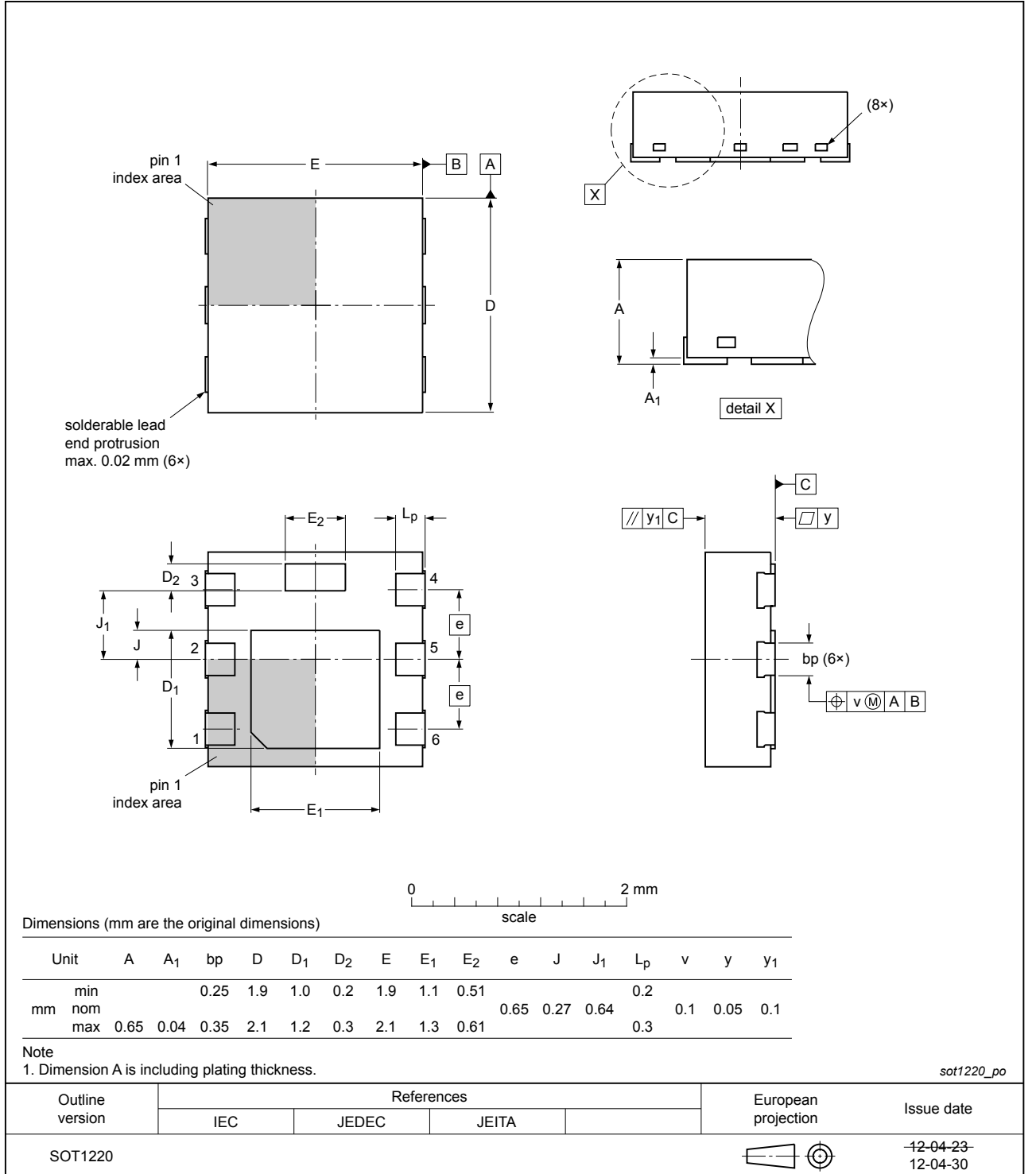


Fig. 18. Package outline DFN2020MD-6 (SOT1220)

### 13. Soldering

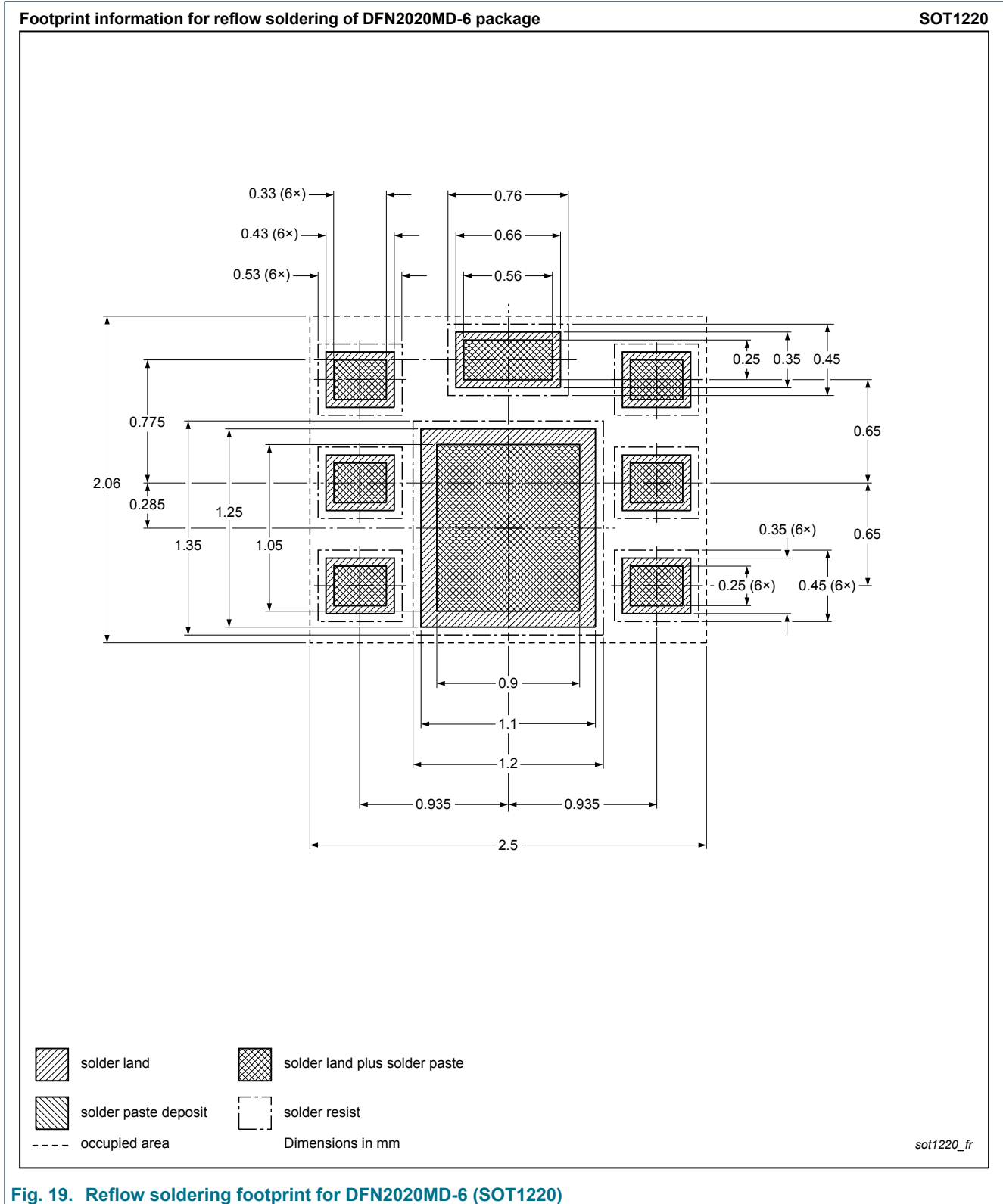


Fig. 19. Reflow soldering footprint for DFN2020MD-6 (SOT1220)

## 14. Revision history

Table 8. Revision history

| Data sheet ID | Release date | Data sheet status  | Change notice | Supersedes |
|---------------|--------------|--------------------|---------------|------------|
| PMPB25ENE v.1 | 20180426     | Product data sheet | -             | -          |

## 15. Legal information

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|--------------------------------|--------------------|---|
| Objective [short] data sheet   | Development        | This document contains data from the objective specification for product development. |
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- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

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